BGA Heat Sink - High Performance Straight Fin w/maxiGRIP





ATS Part#:

Description:

ATS-53250D-C1-R0

25.00 x 25.00 x 9.50 mm BGA Heat Sink - High Performance Straight Fin w/maxiGRIP

Heat Sink Type:Straight FinHeat Sink Attachment:maxiGRIPEquivalent Part Number:ATS-53250D-C2-R0 Discontinued

*Image above is for illustration purpose only.

Features & Benefits

- High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- maxiGRIP™ attachment applies steady, even pressure to the component and does not require holes in the PCB
- Designed specifically for BGAs and other surface mount packages
- Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock Testing and Unpackaged Drop Testing standards
- Comes preassembled with high performance, phase changing, thermal interface material

Thermal Performance

		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	15.3 °C/W	11.6 °C/W	9.8 °C/W	8.7 °C/W	8 °C/W	7.4 °C/W	6.9 °C/W
	Ducted Flow	7.3	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	ТІМ	Finish
	25.00 mm	25.00 mm	9.50 mm	N/A mm	T766	BLACK-ANODIZED
Image above is for illustration purpose only.	 Dimension ATS-5325 (Saint Gol Thermal p application ATS resen performant ATS certif Optional r 	50D-C2-R0 is the ex bain C1100F). NOT performance data ar n. rves the right to upd nce. fies that this heat sir maxiGRIP™ Installa	neight from the botto	bly with an equivale 00F is discontinued ence only. Actual pe oducts without notice S-6 and REACH cor Set P/N: MGT170	ent therma effective rformance e to impre	al interface material 12/31/10. e may vary by

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), **sales@qats.com** or **www.qats.com**.

